

LTspice Model

Fast Recovery Diode

SHINDENGEN

D30FD60K



Model Information

Model A macro model based on general SPICE diode model
Call Name MDC_D30FD60K_LT
Pin Assign 1:NC 2:C 3:A 4:C
File List Model Library MDC_D30FD60K_LT02.lib
 Model Report MDC_D30FD60K_LT.pdf (this file)

Verified Simulator Version LTspice version XVII
Note

References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version Rev.01(2020.01)
- Product name D30FD60K
- Company name Shindengen Electric Manufacturing Co., Ltd.
- Characteristics IfVf[Temp],IrrVr[Temp],CjVr,TrrIflr,TrrWaveform,SurgeWaveform

Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Reverse Voltage	0	to	600	V
Temperature	-55	to	150	deg C

Diode

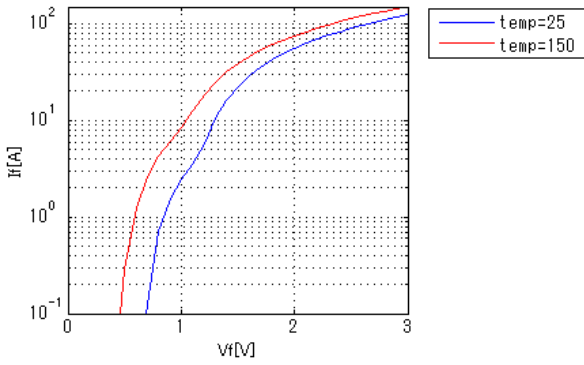
○ : Implemented
× : Not Implemented
— : Not applicable

Model Functions Table
RANK=1

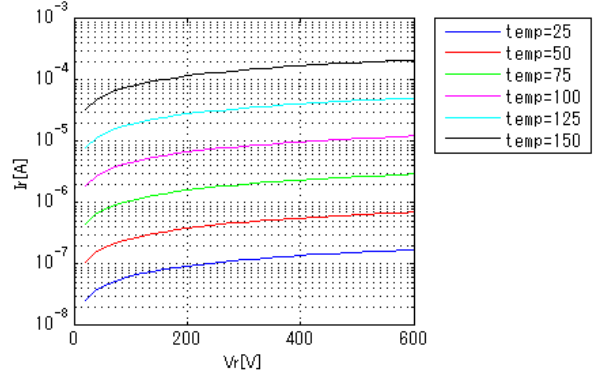
Functions	RANK	Implemented
IF-VF(Temp)	1	○
IR-VR(Temp)	1	○
Capacitance	1	○
Reverse recovery characteristics	1	○
Zz-Iz	1	—
Rectification characteristics(Bridge)	1	—
Surge-Transient	1	○
tlp	1	—

Simulation results are following.
 Explanatory notes — : simulated

IfVf[Temp]

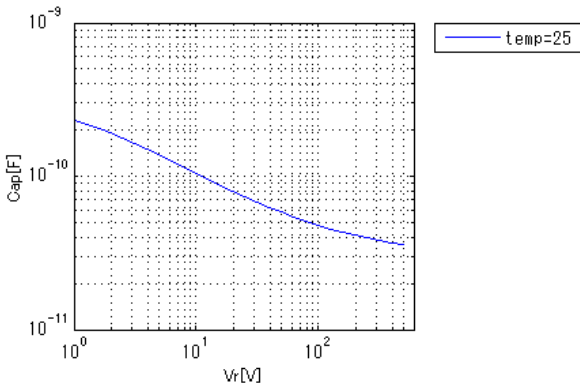


IrVr[Temp]



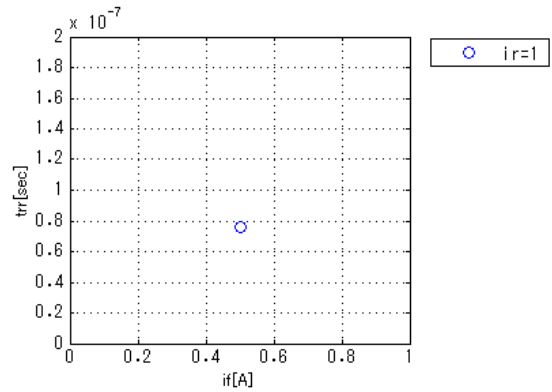
CjVr

Freq = 1000000Hz



TrrIfIr

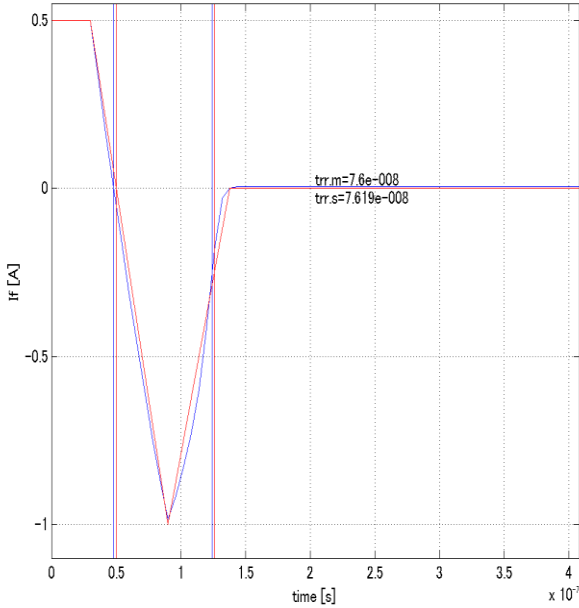
irr = 0.25A, didt = 25A/us



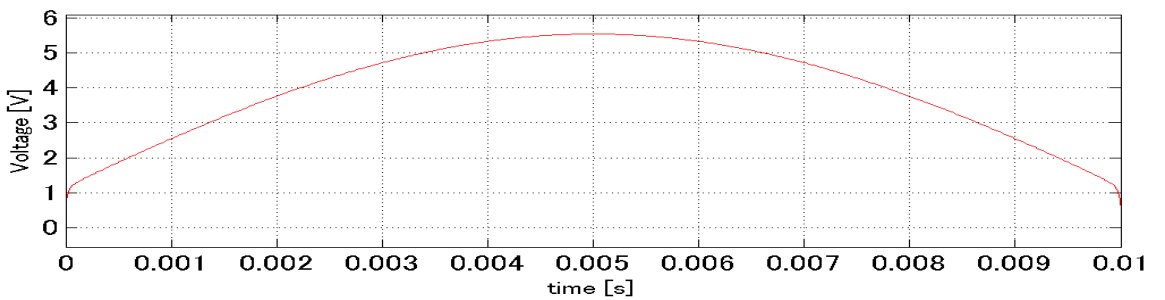
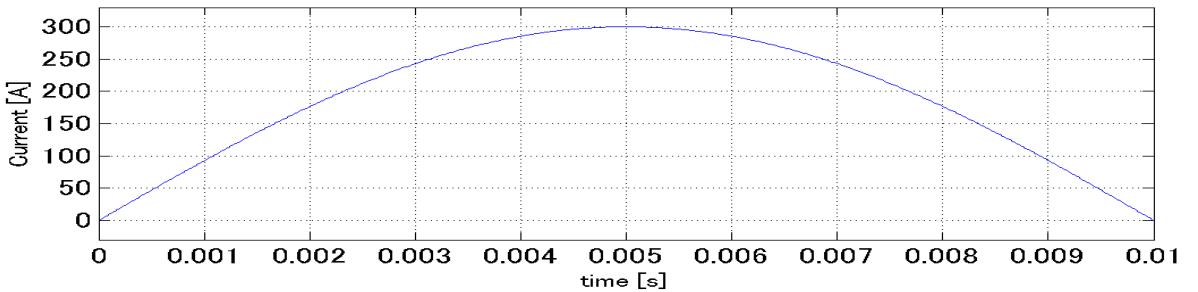
Simulation results are following.
Explanatory notes — : simulated

Trr Waveform (Red : Datasheet Blue : Simulation)

didt = 25A/us, if = 0.5A, ir = 1A, irr = 0.25A



Surge Current Waveform (Forward sine=50Hz)



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